



# CIRCLEPACK

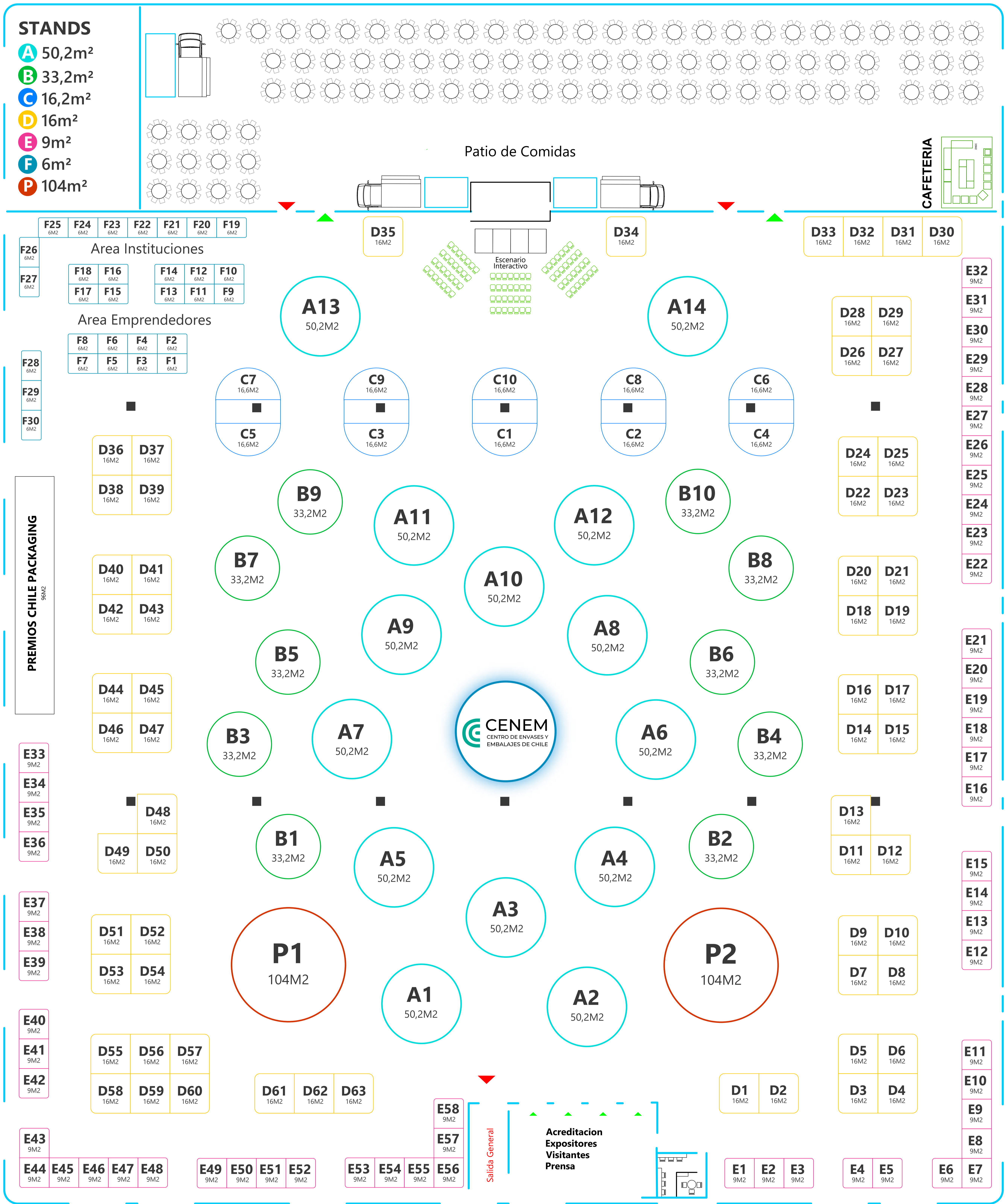
# 14·15·16 APRIL 2026

# CENEM

CENTRO DE ENVASES Y  
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## High-Tech Packaging • Efficiency • Innovation • Sustainability

# PLANO – FERIA INTERNACIONAL DE PACKAGING 2026



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